



DATA SHEET

CURRENT SENSOR - LOW TCR AUTOMOTIVE GRADE

PA_E series 5%, 1%, 0.5% sizes 2512

RoHS compliant & Halogen free



YAGEO Phícomp

Chip Resistor Surface Mount PA_E

<u>SCOPE</u>

This specification describes PA series current sensor - low TCR with lead-free terminations made by metal substrate.

APPLICATIONS

Consumer goods

- Computer
- Telecom / Datacom
- Industrial / Power supply
- Alternative Energy
- Car electronics

FEATURES

- AEC-Q200 qualified
- Halogen-free Epoxy
- RoHS compliant
- Reduce environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production
- Low resistances applied to current sensing
- Anti-sulfur

ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

PA XXXX X X X X XX XXX E

		(3) (0)	(7)	
(I) SIZE				
2512				
(2) TOLERANC	E			
D= ± 0.5%				
$F = \pm 1\%$				
$J = \pm 5\%$				
(3) PACKAGIN	G TYPE			
K = Embosse	d taping reel			
(4) TEMPERATU	JRE COEFFICIEN	NT OF RESIST	TANCE	
F = ± 100 pp	m/°C			
M = ± 75ppn	n/°C			
$E = \pm 50$ ppm	/°C			

(5) TAPING REEL

- 07 = 7 inch dia. Reel & standard power (1W)
- 7W = 7 inch dia. Reel & 2 x standard power (2W)
- 7T = 7 inch dia. Reel & 3 x standard power (3W)

(6) RESISTANCE VALUE

0.5 m Ω to 100 m Ω

(7) DEFAULT CODE

Letter E is the system default code for ordering only. ^(Note)

Resistance rule of global part number						
Resistance code rule	Example					
XUXX	$0U5 = 0.5 \text{m}\Omega$					
ORXXX	$0R001 = 1 m\Omega$					
(I to I00 mΩ)	$0R05 = 50 \text{ m}\Omega$					

ORDERING EXAMPLE

The ordering code of a PA2512 IW chip resistor, TC100, value 0.003Ω with $\pm 1\%$ tolerance, supplied in 7-inch tape reel is: PA2512FKF070R003E

NOTE

I. All our RChip products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead-Free Process"



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MARKING

PA2512



CONSTRUCTION

The resistors are constructed using outstanding TCR level material, which makes Yageo PA resistors excellent for current sensing application in battery charger circuit & DC-DC converter.

The composition of the resistive material is adjusted to give the approximate required resistance and is covered with a protective coating. Marking is printed on the top side of the resistor.

Finally, the three external terminations (Cu / Ni / matte Tin) are added, as shown in Fig. 4.

Outlines



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Chin	Resistor	Surface	Mount	PA E	SERIES	2512

DIMENSION

Table I For outlines, please refer to Fig. 4

TYPE	RESISTANCE RANGE	L (mm)	W (mm)	H (mm)	I⊢(mm)	l ₂ (mm)
	$0.5 \text{m}\Omega \leq \text{R} \leq 0.75 \text{m}\Omega$	6.35±0.25	3.18±0.25	0.63±0.25	2.72±0.25	2.72±0.25
PA2512	$Im\Omega \le R \le 4m\Omega$	6.35±0.25	3.18±0.25	0.63±0.25	2.21±0.25	2.21±0.25
	5m Ω ≤ R ≤ 6m Ω	6.35±0.25	3.18±0.25	0.63±0.25	1.19±0.25	1.19±0.25
	$7m\Omega \le R \le 100m\Omega$	6.35±0.25	3.18±0.25	0.63±0.25	0.76±0.25	0.76±0.25

Note:

1. For relevant physical dimensions, please refer to construction outlines.

2. Please contact with sales offices, distributors and representatives in your region before ordering.

ELECTRICAL CHARACTERISTICS

Table 2

TYPE	SIZE	POWER RATING	TOLERANCE	RESISTANCE RANGE	TEMPERATURE COEFFICIENT		
					OF RESISTANCE		
		IW	±0.5%		±50ppm/°C		
PA	2512	2W	±1%	$0.5 \text{m}\Omega \leq \text{R} \leq 100 \text{m}\Omega$	±75ppm/°C		
		3W	±5%		±100ppm/°C		

Note: Please contact with sales offices, distributors and representatives in your region before ordering.

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

PA2512 Range: -55°C to +170°C

POWER RATING

Standard rated power at 70°C:

For detail power value, please refer to Table 2.

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V = \sqrt{(PxR)}$ Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$



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PACKING	<u>STYLE AND PACKAGING QUANTITY</u>			
Table 3	Packing style and packaging quantity			

PACKING STYLE	REEL DIMENSION	PA2512
Embossed taping reel (K)	7" (178 mm)	4,000

EMBOSSED TAPE



Table 4 Dimensions of embossed tape for relevant chip resistors size

SIZE	SYMBOL										Unit: mm
	A ₀	B ₀	W	Е	F	Po	Pı	P ₂	OD_0	ØD	т
PA2512	2 3.40±0.15	6.70±0.15	12.00±0.30	1.75±0.10	5.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.55±0.05	1.50±0.10	0.80±0.15



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REEL SPECIFICATION



- Table 5 Dimensions of reel specification for relevant chip resistors size

		REE	L SIZE	SYMBOL					Unit: mm
SIZE	PER REEL	8 mm TAPE WIDE	I 2 mm TAPE WIDE	А	Ν	С	D	Wı	W _{2 MAX.}
PA2512	4000		7" (Ø178 mm)	178.0±1.0	60.0+1/-0	13.50±0.5	21.0±0.8	13.6±0.5	16.5±0.5

LEADER/TRAILER TAPE SPECIFICATION



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FOOTPRINT AND SOLDERING PROFILES

For recommended soldering profiles, please refer to data sheet "Chip resistors mounting".

FOOTPRINT



Table 6 Footprint dimensions

	RESISTANCE				
SIZE	RANGE	А	В	С	D
PA2512	$0.5 \text{m}\Omega \leq \text{R} < 1 \text{m}\Omega$	7.36	0.50	3.43	3.68
	$Im\Omega \le R \le 4m\Omega$	7.37	1.27	3.05	3.68
	$5m\Omega \le R \le 6m\Omega$	7.40	3.18	2.11	3.68
	$7m\Omega \le R \le 100m\Omega$	7.36	4.06	1.65	3.68

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TESTS AND REQUIREMENTS

Table 8 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENT
Short time overload	IEC60115-14.13	5 times of rated power for 5 seconds at room temperature	±(0.5%+0.0005 Ω) No visible damage
High Temperature Exposure	MIL-STD-202-Method 108	I,000 hours at maximum operating temperature depending on specification, unpowered	±(1.0%+0.0005 Ω)
		No direct impingement of forced air to the parts Tolerances: I70±3°C	
Temperature Cycling	JESD22-A104C	1,000 cycles, -55/+125°C for 1 cycle per hour	$\pm (0.5\% + 0.0005 \Omega)$
Moisture Resistance	MIL-STD-202-Method 106	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25°C / 65°C 95% R.H, without steps 7a & 7b, unpowered	±(0.5%+0.0005 Ω)
Biased Humidity	MIL-STD-202 Method 103	I ,000 hours; 85°C / 85% RH I 0% of operating power	$\pm (0.5\% + 0.0005 \Omega)$
Operational Life/ Endurance	MIL-STD-202-Method 108	1,000 hours at 125±3°C, de-rated voltage applied for 1.5 hours on, 0.5 hour off, still- air required	±(1.0%+0.0005 Ω)
		I,000 hours at 70±2°C applied RCWV I.5 hours on, 0.5 hour off, still air required	±(1.0%+0.0005 Ω)
Resistance to Solvents	MIL-STD-202 Method 215	Immerse in isopropyl alcohol for 5 min with ultrasonic at room temperature	No Visible damage
Mechanical Shock	MIL-STD-202 Method 213	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen.	±(0.5%+0.0005 Ω)
		Peak value: 100 g's	
		Duration: 6 ms	
		Velocity change: 12.3 ft/s	
		Waveform: Half sine	
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations	$\pm (0.5\% + 0.0005 \Omega)$
		Test from 10-2000 Hz.	
Resistance to	MIL-STD-202-method 210	Condition B, no pre-heat of samples	$\pm (0.5\% + 0.0005 \Omega)$
Soldering Heat		Leadfree solder, 260°C, 10 seconds immersion time	No visible damage
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	
Thermal Shock	MIL-STD-202 Method 107	-55/+125°C, Number of cycles is 300.	±(0.5%+0.0005 Ω)
		Devices mounted.	No visible damage
		Maximum transfer time is 20 seconds.	
		Dwell time is 15 minutes. Air -Air	



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TEST	TEST METHOD	PROCEDURE	REQUIREMENT
Electrostatic	AEC-Q200-002	Human Body Model, I pos + I neg.	\pm (1.0%+0.0005 Ω)
Discharge		Discharges 2512=2KV	No visible damage
Solderability - Wetting	J-STD-002B test B	(a) Method B, aging 4 hours at 155°C dry heat, dipping at 235±3°C for 5±0.5 seconds.	Well tinned (>95% covered) No visible damage
		(b) Method B, steam aging 8 hours, dipping at 215±3°C for 5±0.5 seconds.	
		(c) Method D, steam aging 8 hours, dipping at 260±3 °C for 7±0.5 seconds.	
Flammability	UL94	Try to inflame a specimen by a needle flame	No ignition of specimen; V-0
Board Flex / Bending	AEC-Q200-005	Chips mounted on a 90mm glass epoxy resin PCB (FR4), Bending for 2512=2 mm	$\pm(1.0\%+0.0005\Omega)$
		Holding time: Min.60 seconds	
Terminal Strength (SMD)	AEC-Q200-006	Applied a 17.7N (1.8Kg) for 60 ± 1 seconds.	±(1.0%+0.0005 Ω) No visible damage
Flame Retardance	AEC-Q200-001	Apply voltage from 9V to 32V to increase the surface temp to 350°C	No flame, no explosion
Temperature	MIL-STD-202 Method 304	At +25/+150°C	Refer to table 2
Coefficient of $T \subset R$		Formula:	
Resistance (T.C.R.)		T.C.R= $\frac{\mathbf{R}_2 - \mathbf{R}_i}{\mathbf{RI}(\mathbf{t}_2 - \mathbf{t}_i)} \times 10^6 (\text{ppm/°C})$	
		Where	
		tI=+25°C or specified room temperature	
		t2=+150°C test temperature	
		RI=resistance at reference temperature in ohms	
		R2=resistance at test temperature in ohms	
Flower-of-Sulfur (FOS)	Modified ASTM B809-95	Sulfur 105°C, 750 hours, unpowered.	±(1.0%+0.0005 Ω)

